

1SS355 Silicon Epitaxial Planar Switching Diode

Features

- Small plastic package suitable for surface mounted design
- High reliability with high surge current handling capability

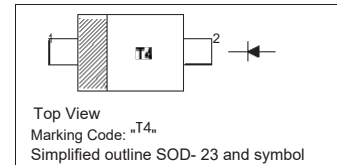
Applications

- High speed switching

MARKING: T4

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Absolute Maximum Ratings ($T_a = 25^{\circ}\text{C}$)

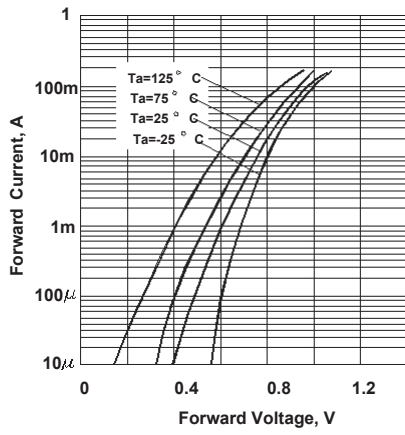
Parameter	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	90	V
Reverse Voltage	V_R	80	V
Average Rectified Forward Current	$I_{F(AV)}$	100	mA
Peak Forward Current	I_{FM}	225	mA
Surge Forward Current (1 s)	I_{FSM}	500	mA
Junction Temperature	T_j	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	- 55 to + 150	$^{\circ}\text{C}$

Electrical Characteristics ($T_a = 25^{\circ}\text{C}$)

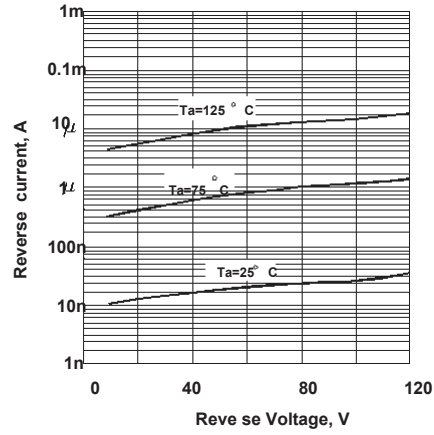
Parameter	Symbol	Max.	Unit
Forward Voltage at $I_F = 100$ mA	V_F	1.2	V
Reverse Current at $V_R = 80$ V	I_R	0.1	μA
Capacitance between Terminals at $V_R = 0.5$ V, $f = 1$ MHz	C_T	3	pF
Reverse Recovery Time at $V_R = 6$ V, $I_F = 10$ mA, $R_L = 100$	t_{rr}	4	ns

Typical Characteristics

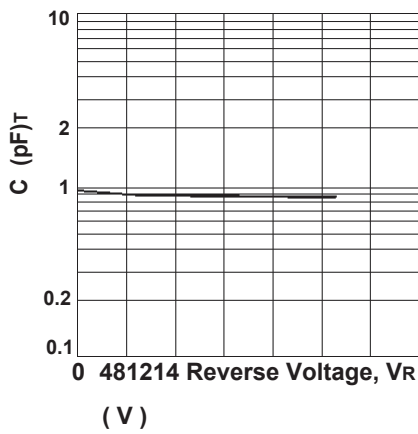
Forward Characteristics



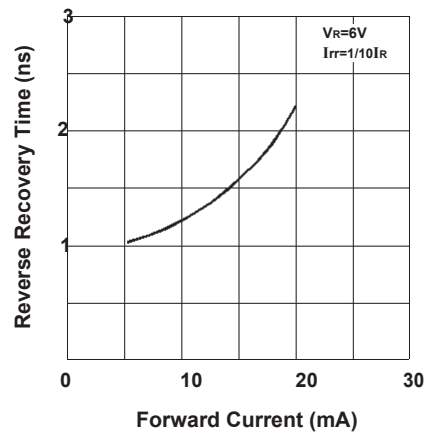
Reverse Characteristics



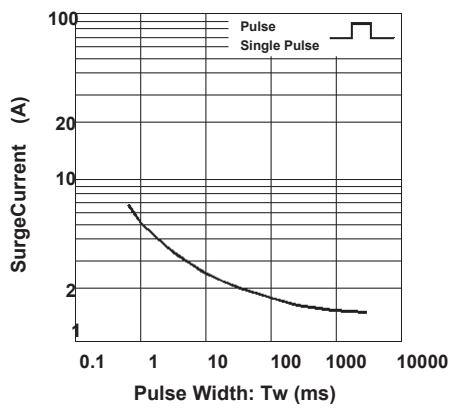
Capacitance between terminals characteristics



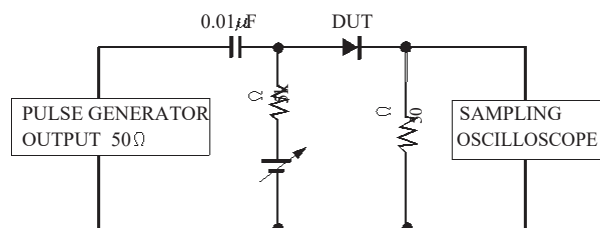
Reverse Recovery Time Characteristics



Surge Current Characteristics



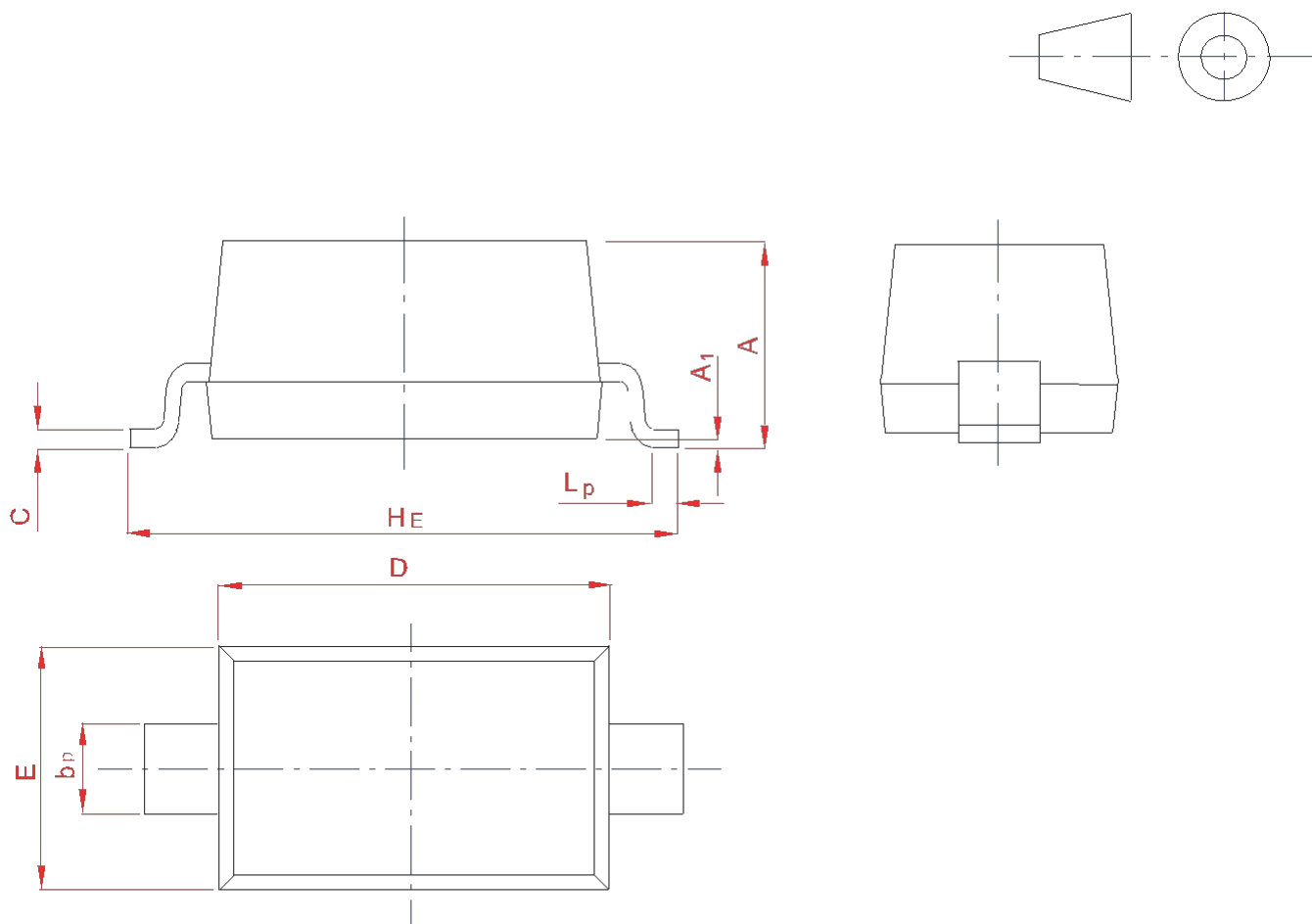
Reverse Recovery Time Measurement Circuit



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123



UNIT	A	bp	C	D	E	HE	A1	Lp
mm	1.20	0.60	0.135	2.75	1.65	3.85	0.10	0.50
	0.90	0.50	0.100	2.55	1.55	3.55	0.01	0.20